

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	4	"716"/\$.ccls. and ((printed adj circuit adj board) or pcb) and (covered with (resin or insulat\$3)) and @ad<"20021002"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/16 09:10
L2	2	"20040068703"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/16 09:24
L3	1374	(covered with (insulating adj2 resin))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/16 09:44
L5	217	(wir\$3 with covered with (insulating adj2 resin)) and @ad<"20021002"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/16 09:27
L6	1	server and (wir\$3 with covered with (insulating adj2 resin)) and @ad<"20021002"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/16 09:33
L7	4	"6256769".pn. "20010044667"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/16 09:34
L8	0	(covered with (insulating adj2 resin)) and ((single adj2 layer) with multi\$1layer) and "716"/\$. CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/16 09:46
L9	261	maehara-eiju.in.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/16 10:12
L10	0	(isb with sip).CLM.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/16 10:20

L11	3	((single adj2 layer) with (multilayer) and (insulating adj2 resin)).CLM.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/16 10:14
L13	0	((single adj2 layer) with (multilayer) and (covered adj3 insulating adj2 resin)).CLM.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/16 10:16
L14	2108	716/4.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/16 10:15
L15	1343	716/1.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/16 10:15
L16	2	((single adj2 layer) with (multilayer) and (covered adj3 insulating adj2 resin))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/16 10:16
L17	7	"716"/\$.ccls. and ((printed adj circuit adj board) or pcb) and (internet or server) and insulat\$3 and multi\$1layer	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/16 10:19
L18	8	(isb with sip)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/16 10:22
L19	16	((isb or (integrated adj sytem adj2 board)) with (sip or (system adj2 package)))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/16 10:24
S4	34	"716"/\$.ccls. and ((printed adj circuit adj board) or pcb) and resin	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/16 09:07
S6	5	"716"/\$.ccls. and ((server or internet) with reliability)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/08 16:10

S7	213	"716"/\$.ccls. and ((printed adj circuit adj board) or pcb) and (internet or server)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/16 10:18
S8	2	"6594799".pn.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/08 16:31
S9	2	"20040098391"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/16 09:22
S10	4	"716"/\$.ccls. and ((printed adj circuit adj board) or pcb) and (internet or server) and resin	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/09 07:58
S11	2	"6530065".pn.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/09 08:00
S12	2	"6634008".pn.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/09 08:00
S13	10	("5862223"   "5878408"   "5933356"   "6058426"   "6102961"   "6141724"   "6269467").PN. OR ("6594799").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/09/09 08:03
S14	4	"716"/\$.ccls. and ((printed adj circuit adj board) or pcb) and (internet or server) and resin	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/09 08:27
S15	2	"20010044667"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/09 08:46
S16	4	"20010044667" "6256769".pn.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/09 10:58